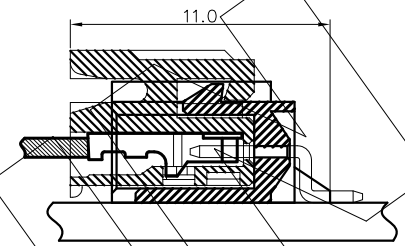
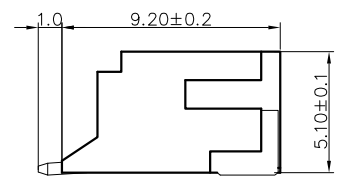
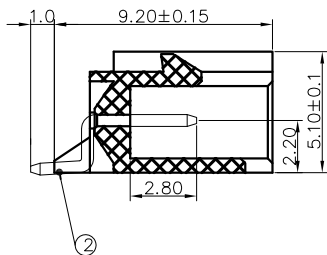
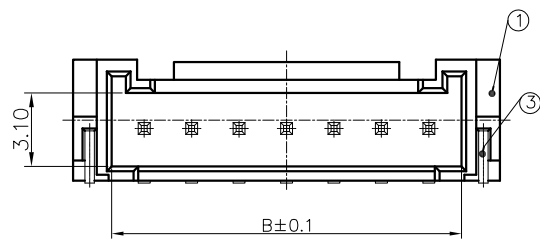
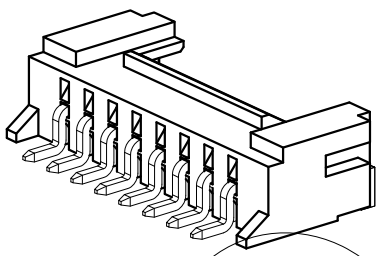
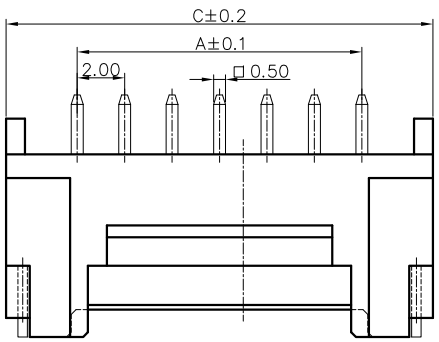


零件图	成品图	客户图
		○

REVISION DATA				
REV	ECN No.	DESCRIPTION	NAME	DATE
A0		NEW DRAWING	Zhang	2017-09-04



PIN	A	B	C
2	2.0	4.75	8.0
3	4.0	6.75	10.0
4	6.0	8.75	12.0
5	8.0	10.75	14.0
6	10.0	12.75	16.0
7	12.0	14.75	18.0
8	14.0	16.75	20.0
9	16.0	18.75	22.0
10	18.0	20.75	24.0
11	20.0	22.75	26.0
12	22.0	24.75	28.0
13	24.0	26.75	30.0
14	26.0	28.75	32.0
15	28.0	30.75	34.0
16	30.0	32.75	36.0

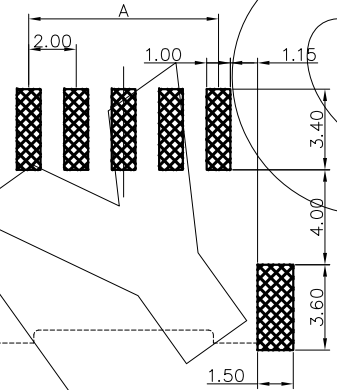


Technical Data

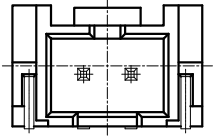
Material:
 Contact Material: Copper Alloy
 Contact plating: Au or Sn Over Ni
 Insulator Material: See the table, UL94 V-0

Electrical:
 Rating current: 2Amps/contact max.
 Rating voltage : 125 V AC/DC
 Contact resistance: ≤30mΩ/contact
 Insulation resistance: ≥1000MΩ
 Withstanding Voltage: 1000V AC/minute

Mechanical:
 Operating temperatures: Gold Plated: -55°C to +105°C
 Tin plated: -40°C to +105°C
 Soldering temperature: +260°C, max(PA66)
 +220°C, max(PBT)



Recommended P.B.C. Layout



2PIN

WF	B	H	XXX	XX	X	N	H003
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B PH 2.0 H-SMT

Pin No.
No. of Positions
XXX Positions

Plated
SN Tin 120 μ"

Material

- A PBT
- B PA-66
- C PA-6T
- D LCP
- E PA-46
- F PA-9T
- H PA4T

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东莞市恩康电子科技有限公司

DONGGUAN ENKANG ELECTRONICS TECHNOLOGY CO.,LTD

TOLERANCE	DATE : 2017-09-04	TITLE: PH2.00 H9.2 SMT WAFER
ANGLE ±5°	DRAWN : Zhang	PART NO: WFBHXXXXXXXXNH003
X.XXX ±0.15	CHECKED :	
X.XX ±0.25	APPROVED :	
X.X ±0.40	PROJECTON	REV: A0
X. ±0.50		UNIT: mm
		SCALE: 1:1
		SIZE: A4
		PAGE: 1/1